

HSF

NOTES:

Current Rating: 2.0AMP

Contact Resistance: 20mΩ Max

Withstand Voltage: 500V AC/DC

Insulation Resistance: 1000MΩ Min

Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze

Contact plating: Au Or Sn over Ni

Insulator Material: LCP+30%G.F UL94V-0



D

Ordering Information

2263D - 2 XX S XX DYN X X

No. of Pins per
ROW: 02-40PIN

Contact Plating:
G0=Gold Flash
G3=10μ"Gold
G4=15μ"Gold
G5=30μ"Gold
S0=Gold Flash/Tin
S3=10μ"Gold/Tin
S4=15μ"Gold/Tin
S5=30μ"Gold/Tin
SN=Tin
SM=Matte Tin

Insulator:
D=LCP

Packing:
T=Tube

E

F

Item	Pitch	Mating
Standard	2.00	1215/1220
Alternate		

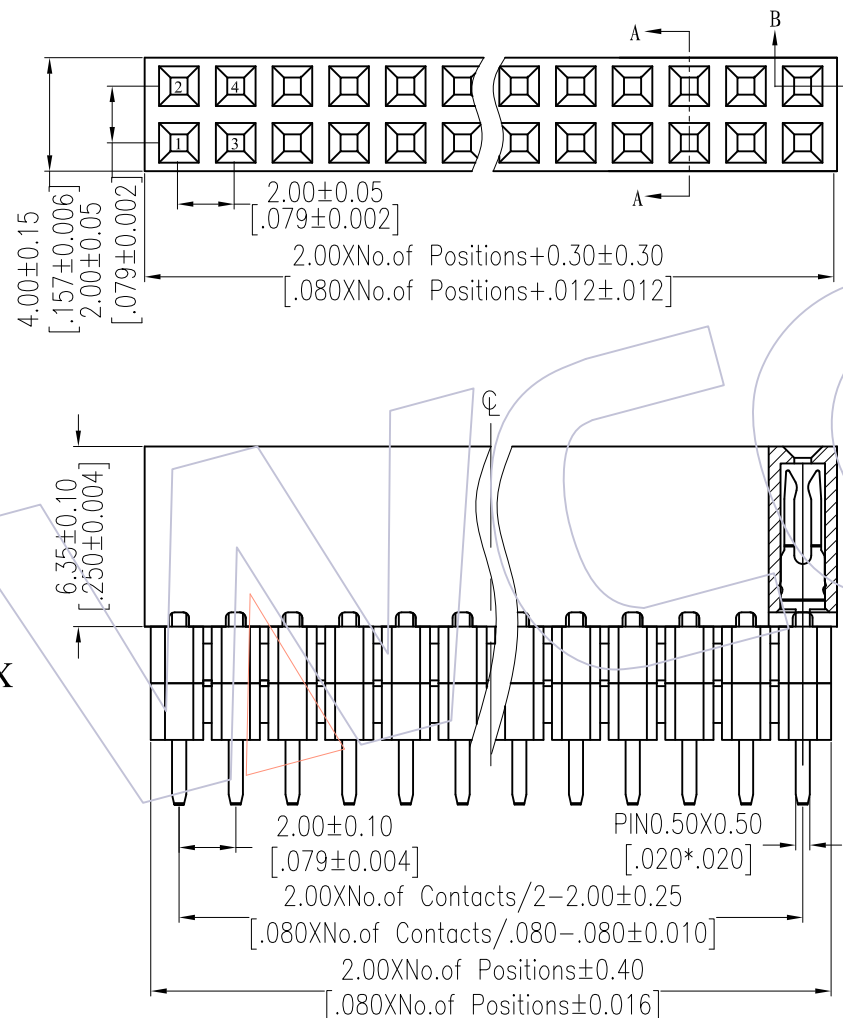
G

H

H

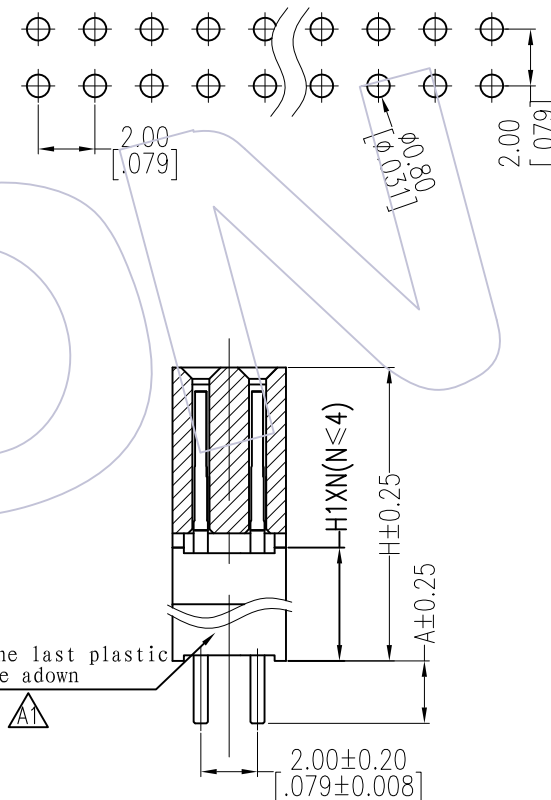
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REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
A2	2013/04/26	Modify drawing	-----	X.X ±0.40	Wang	2013/04/26	UNIT	mm	2263D-2XXSXXDYNXX
A1	2012/11/07	Modificat right table (Add high explain)	-----	X.XX ±0.25	CHECK	DATE	SIZE	A4	TITLE: FH2.00mm DUAL ROW H=6.35 180° DIP ADD HOUSING
A0	2012/07/23	NEW	-----	X.XXX ±0.15	APPROVE	DATE	SHEET	1/1	Customer NO.
				Angle ± 3°			PROJ.		
				DIM TOL					



SECTION B-B

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



SECTION A-A

DIMENSION ANTITHESSES LIST			
H1XN(N≤4)	A	H	H1
STANDARD	3.28	8.35	1.50/ 2.00
	2.28	9.35	
	3.80	7.85	
	12.20	9.35	
	2.28	19.30	
ALTERNATE	13.10	8.35	